NX3L2G384

Dual low-ohmic single-pole single-throw analog switch

Rev. 01 — 18 September 2008

Product data sheet

1. General description

The NX3L2G384 provides two low-ohmic single pole single throw analog switch functions. Each switch has two input/output terminals (nY and nZ) and an active LOW enable input $(n\overline{E})$. When pin $n\overline{E}$ is HIGH, the analog switch is turned off.

Schmitt-trigger action at the enable input ($n\overline{E}$) makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 1.4 V to 3.6 V.

The NX3L2G384 allows signals with amplitude up to V_{CC} to be transmitted from nY to nZ; or from nZ to nY. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features

- Wide supply voltage range from 1.4 V to 3.6 V
- Very low ON resistance (peak):
 - 1.6 Ω (typical) at $V_{CC} = 1.4 \text{ V}$
 - 1.0 Ω (typical) at $V_{CC} = 1.65 \text{ V}$
 - 0.55 Ω (typical) at $V_{CC} = 2.3 \text{ V}$
 - 0.50 Ω (typical) at $V_{CC} = 2.7 \text{ V}$
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114E Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - ◆ CDM AEC-Q100-011 revision B exceeds 1000 V
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Direct interface with TTL levels at 3.0 V
- Control input accepts voltages above supply voltage
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

- Cell phone
- PDA
- Portable media player



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4. Ordering information

Table 1. Ordering information

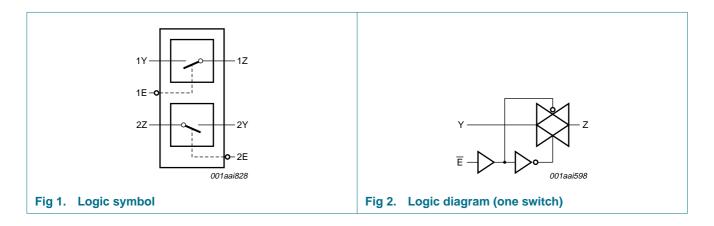
Type number	Package								
	Temperature range	Name	Description	Version					
NX3L2G384GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm	SOT833-1					
NX3L2G384GM	–40 °C to +125 °C	XQFN8	plastic extremely thin quad flat package; no leads; 8 terminals; body 1.6 \times 1.6 \times 0.5 mm	SOT902-1					

5. Marking

Table 2. Marking

Type number	Marking code
NX3L2G384GT	ML2
NX3L2G384GM	ML2

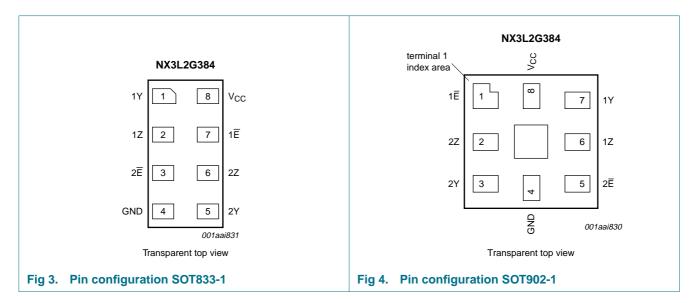
6. Functional diagram



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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin SOT833-1 SOT902-1		Description			
1Y, 2Y	1, 5	7, 3	independent input or output			
1Z, 2Z	2, 6	6, 2	independent output or input			
GND	4	4	ground (0 V)			
1Ē, 2Ē	7, 3	1, 5	enable input (active LOW)			
V_{CC}	8	8	supply voltage			

8. Functional description

Table 4. Function table[1]

Input nE	Switch
L	ON
Н	OFF

[1] H = HIGH voltage level;

L = LOW voltage level.

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9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+4.6	V
V_{I}	input voltage		<u>[1]</u>	-0.5	+4.6	V
V_{SW}	switch voltage		[2]	-0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	$V_1 < -0.5 \text{ V}$		-50	-	mΑ
I _{SK}	switch clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±50	mΑ
I _{SW}	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current		-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10% duty cycle; peak current		-	±500	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3]	-	250	mW

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.4	-	3.6	V
VI	input voltage	enable input nĒ	0	-	3.6	V
V_{SW}	switch voltage		<u>[1]</u> 0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	[2] _	-	200	ns/V

^[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nY. In this case, there is no limit for the voltage drop across the switch.

^[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

^[3] For XSON8 and XQFN8 packages: above 45 °C the value of Ptot derates linearly with 2.4 mW/K.

^[2] Applies to control signal levels.

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11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions		25 °C		-40	°C to +12	5 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V_{IH}	HIGH-level	V _{CC} = 1.4 V to 1.95 V	0.65V _{CC}	-	-	0.65V _{CC}	-	-	V
	input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	-	V
V_{IL}	LOW-level	V _{CC} = 1.4 V to 1.95 V	-	-	0.35V _{CC}	-	0.35V _{CC}	0.35V _{CC}	V
	input voltage	V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	8.0	-	8.0	8.0	V
I _I	input leakage current	enable input $n\overline{E}$; $V_I = GND$ to 3.6 V; $V_{CC} = 1.4$ V to 3.6 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	nY port; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$ see Figure 5	-	-	±5	-	±50	±500	nA
I _{S(ON)}	ON-state leakage current	nZ port; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$ see Figure 6	-	-	±5	-	±50	±500	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$	-	-	100		690	6000	nA
Cı	input capacitance		-	1.0	-	-	-	-	pF
C _{S(OFF)}	OFF-state capacitance		-	35	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	110	-	-	-	-	pF

11.1 Test circuits

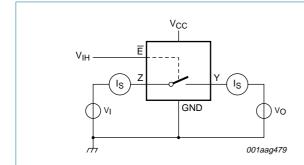
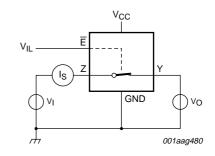


Fig 5. Test circuit for measuring OFF-state leakage current

 V_I = 0.3 V or V_{CC} – 0.3 V; V_O = V_{CC} – 0.3 V or 0.3 V.



 V_I = 0.3 V or V_{CC} – 0.3 V; V_O = open circuit.

Fig 6. Test circuit for measuring ON-state leakage current

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11.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 13.

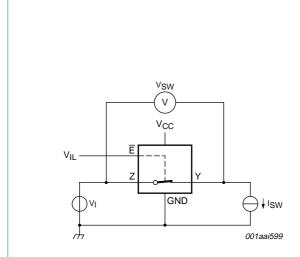
Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	V_I = GND to V_{CC} ; I_{SW} = 100 mA; see Figure 7							
		V _{CC} = 1.4 V		-	1.6	3.7	-	4.1	Ω
		V _{CC} = 1.65 V		-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 \text{ V}$		-	0.55	0.8	-	0.9	Ω
		$V_{CC} = 2.7 \text{ V}$		-	0.5	0.75	-	0.9	Ω
ΔR_{ON}	ON resistance mismatch between channels	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	[2]						
		$V_{CC} = 1.4 \text{ V}$		-	0.04	0.3	-	0.3	Ω
		$V_{CC} = 1.65 \text{ V}$		-	0.04	0.2	-	0.3	Ω
		$V_{CC} = 2.3 \text{ V}$		-	0.02	0.08	-	0.1	Ω
		$V_{CC} = 2.7 \text{ V}$		-	0.02	0.075	-	0.1	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	[3]						
		$V_{CC} = 1.4 \text{ V}$		-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V		-	0.5	1.2	-	1.3	Ω
		$V_{CC} = 2.3 \text{ V}$		-	0.15	0.3	-	0.35	Ω
		$V_{CC} = 2.7 \text{ V}$		-	0.13	0.3	-	0.35	Ω

^[1] Typical values are measured at T_{amb} = 25 °C.

^[2] Measured at identical V_{CC}, temperature and input voltage.

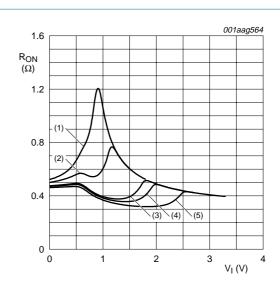
^[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

11.3 ON resistance test circuit and graphs



 $R_{ON} = V_{SW} / I_{SW}$

Fig 7. Test circuit for measuring ON resistance

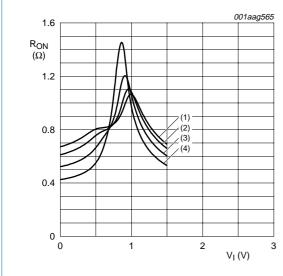


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- (1) $V_{CC} = 1.5 \text{ V}.$
- (2) $V_{CC} = 1.8 \text{ V}.$
- (3) $V_{CC} = 2.5 \text{ V}.$
- (4) $V_{CC} = 2.7 \text{ V}.$
- (5) $V_{CC} = 3.3 \text{ V}.$

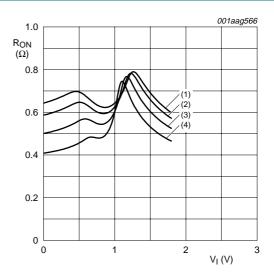
Measured at T_{amb} = 25 °C.

Fig 8. Typical ON resistance as a function of input voltage



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 9. ON resistance as a function of input voltage; $V_{CC} = 1.5 \text{ V}$



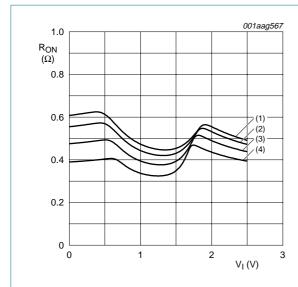
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 10. ON resistance as a function of input voltage; $V_{CC} = 1.8 \text{ V}$

NX3L2G384_1

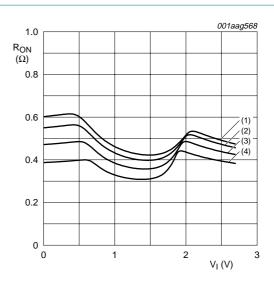
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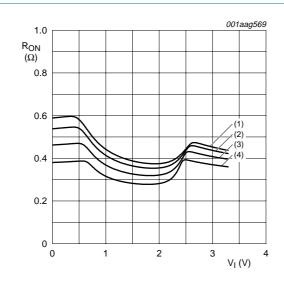
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 11. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 12. ON resistance as a function of input voltage; $V_{CC} = 2.7 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 13. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}$

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12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 15.

	, ,	, ,		,,						
Symbol	Parameter	er Conditions		25 °C		-40	°C to +12	5 °C	Unit	
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)		
t _{en}	enable time	nE to nZ or nY; see Figure 14								
		V_{CC} = 1.4 V to 1.6 V	-	27	41	-	44	48	ns	
		V_{CC} = 1.65 V to 1.95 V	-	23	35	-	37	40	ns	
		V_{CC} = 2.3 V to 2.7 V	-	17	26	-	28	31	ns	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	14	24	-	25	27	ns	
t _{dis}	disable time	nE to nZ or nY; see Figure 14								
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	9	17	-	19	21	ns	
		V_{CC} = 1.65 V to 1.95 V	-	7	13	-	14	15	ns	
		V_{CC} = 2.3 V to 2.7 V	-	4	8	-	9	10	ns	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	3	7	-	8	9	ns	

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.

12.1 Waveform and test circuits

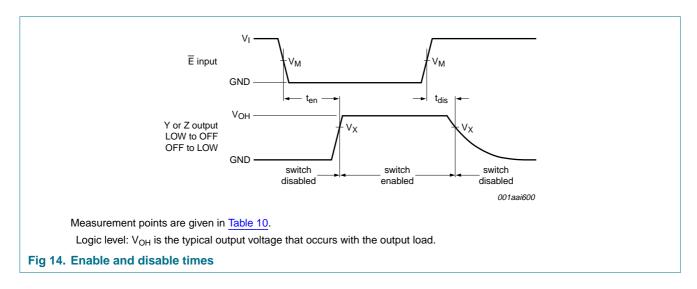
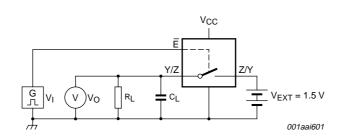


Table 10. Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _X
1.4 V to 3.6 V	0.5V _{CC}	0.9V _{OH}

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Test data is given in Table 11.

Definitions test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 V_{EXT} = External voltage for measuring switching times.

Fig 15. Load circuit for switching times

Table 11. Test data

Supply voltage	Input		Load		
V _{CC}	VI	t _r , t _f	CL	R _L	
1.4 V to 3.6 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω	

12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); V_l = GND or V_{CC} (unless otherwise specified); t_r = $t_f \le 2.5$ ns.

Symbol	Parameter	Conditions			25 °C		Unit
					Тур	Max	
THD	total harmonic	f_i = 20 Hz to 20 kHz; R_L = 32 Ω ; see Figure 16	<u>[1]</u>				
	distortion	$V_{CC} = 1.4 \text{ V}; V_I = 1 \text{ V (p-p)}$		-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)		-	0.10	-	%
		$V_{CC} = 2.3 \text{ V}; V_I = 1.5 \text{ V (p-p)}$		-	0.015	-	%
		$V_{CC} = 2.7 \text{ V; } V_I = 2 \text{ V (p-p)}$		-	0.024	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 17	<u>[1]</u>				
	response	V _{CC} = 1.4 V to 3.6 V		-	60	-	MHz
α_{iso}	isolation (OFF-state)	f_i = 100 kHz; R_L = 50 Ω ; see Figure 18	<u>[1]</u>				
		V _{CC} = 1.4 V to 3.6 V		-	-90	-	dB
V_{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1$ MHz; $C_L = 50$ pF; $R_L = 50$ Ω ; see Figure 19					
		V _{CC} = 1.4 V to 3.6 V		-	0.16	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz}$; $R_L = 50 \Omega$; see Figure 20	[1]				
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$		-	-90	-	dB

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Table 12. Additional dynamic characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns.

Symbol	Parameter	Conditions	25 °C			Unit
			Min	Тур	Max	
Q _{inj}	charge injection	f_i = 1 MHz; C_L = 0.1 nF; R_L = 1 M Ω ; V_{gen} = 0 V; R_{gen} = 0 Ω ; see <u>Figure 21</u>				
		V _{CC} = 1.5 V	-	3	-	рС
		V _{CC} = 1.8 V	-	3	-	pC
		$V_{CC} = 2.5 \text{ V}$	-	3	-	pC
		$V_{CC} = 3.3 \text{ V}$	-	3	-	pC

^[1] f_i is biased at 0.5 V_{CC} .

13. Test circuits

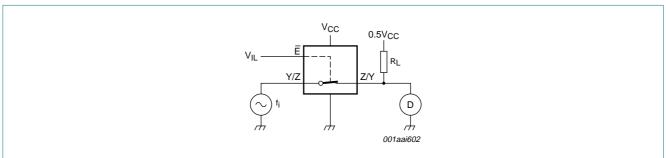
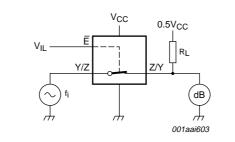


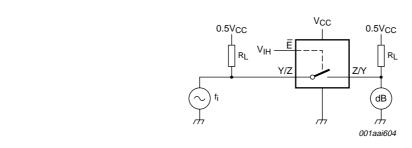
Fig 16. Test circuit for measuring total harmonic distortion



Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads -3 dB.

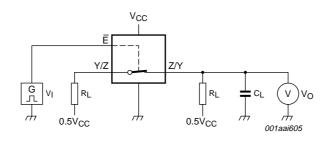
Fig 17. Test circuit for measuring the frequency response when channel is in ON-state

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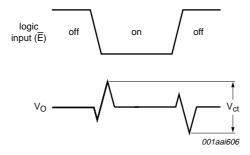


Adjust fi voltage to obtain 0 dBm level at input.

Fig 18. Test circuit for measuring isolation (OFF-state)



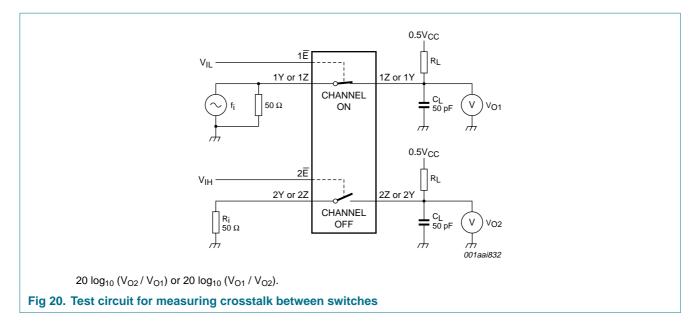
a. Test circuit

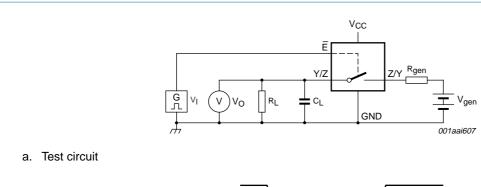


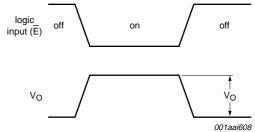
b. input and output pulse definitions

Fig 19. Test circuit for measuring crosstalk voltage between digital inputs and switch

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b. Input and output pulse definitions

Definition: $Q_{inj} = \Delta V_O \times C_L$.

 ΔV_{O} = output voltage variation.

R_{gen} = generator resistance.

 V_{gen} = generator voltage.

Fig 21. Test circuit for measuring charge injection

14. Package outline

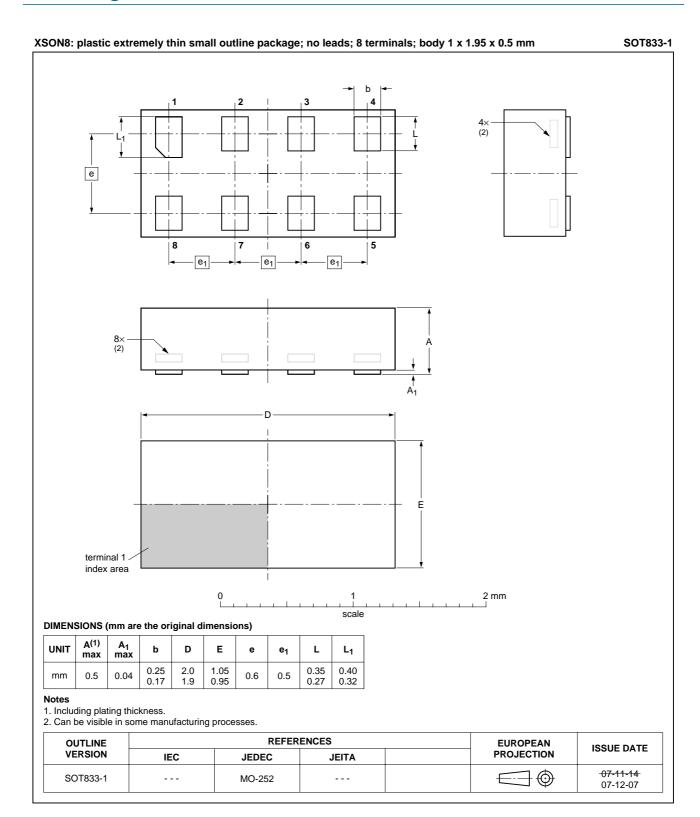


Fig 22. Package outline SOT833-1 (XSON8)

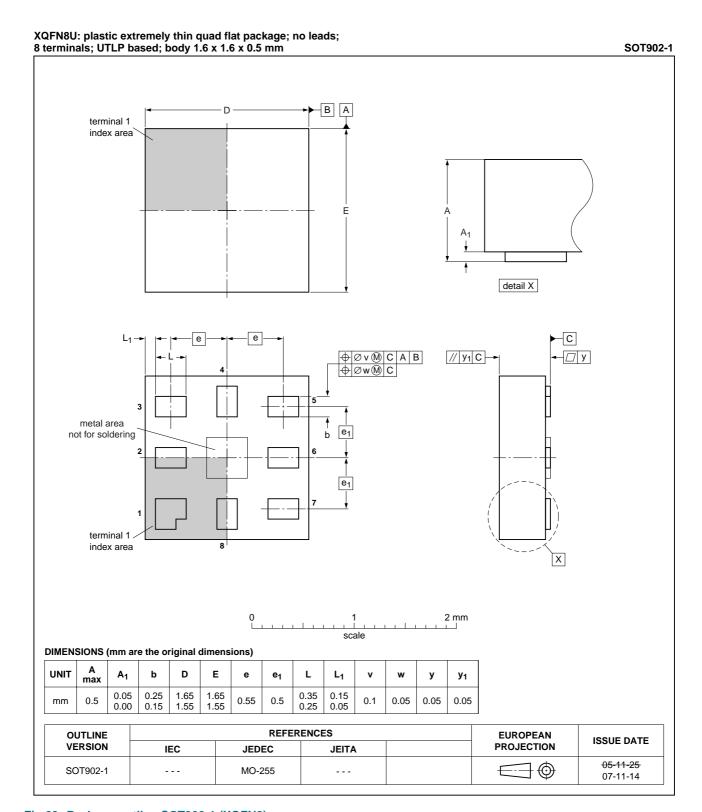


Fig 23. Package outline SOT902-1 (XQFN8)

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15. Abbreviations

Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

16. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L2G384_1	20080918	Product data sheet	-	-

Dual low-ohmic single-pole single-throw analog switch

17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Dual low-ohmic single-pole single-throw analog switch

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